To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HD74LV163A

Synchronous 4-bit Binary Counter (Synchronous Clear)

REJ03D0320–0500Z
(Previous ADE-205-265C (Z))
Rev.5.00
Jun. 04, 2004

Description

The HD74LV163A is 4-bit binary counters. All flip flops are clocked simultaneously on the low to high to transition (positive edge) of the clock input waveform. These counters may be preset using the load input. Presetting of all four flip flops is synchronous to the rising edge of clock. When load is held low counting is disabled and the data on the A, B, C and D inputs is loaded into the counter on the rising edge clock. If the load input is taken high before the positive edge of clock, the count operation will be unaffected.

Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- V_{CC} = 2.0 V to 5.5 V operation
- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V)
- All outputs V_O (Max.) = 5.5 V (@V_{CC} = 0 V)
- Typical V_{OL} ground bounce < 0.8 V (@V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.3 V (@V_{CC} = 3.3 V, Ta = 25°C)
- Output current ±6 mA (@V_{CC} = 3.0 V to 3.6 V), ±12 mA (@V_{CC} = 4.5 V to 5.5 V)
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV163AFPEL	SOP–16 pin(JEITA)	FP–16DAV	FP	EL (2,000 pcs/reel)
HD74LV163ARPEL	SOP–16 pin(JEDEC)	FP–16DNV	RP	EL (2,500 pcs/reel)
HD74LV163ATELL	TSSOP–16 pin	TTP–16DAV	T	ELL (2,000 pcs/reel)

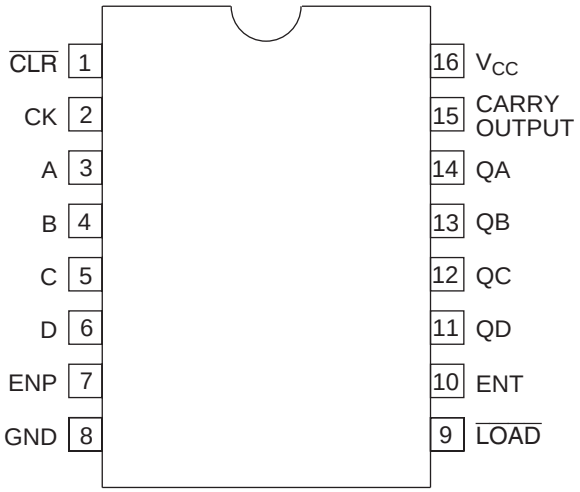
Note: Please consult the sales office for the above package availability.

Function Table

Inputs					Outputs			
$\overline{CLR}$	$\overline{LOAD}$	ENP	ENT	CLK	QA	QB	QC	QD
L	X	X	X	↑	L	L	L	L
H	L	X	X	↑	A	B	C	D
H	H	X	L	↑	No change			
H	H	L	X	↑	No change			
H	H	H	H	↑	Count up			
X	X	X	X	↓	No change			

Note: H: High level
L: Low level
X: Immaterial
↑: Low to high transition
↓: High to low transition
A, B, C, D: Data input
Carry = ENT • QA • QB • QC • QD

Pin Arrangement



(Top view)

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V_{CC}	–0.5 to 7.0	V	
Input voltage range*[1]	V_I	–0.5 to 7.0	V	
Output voltage range*[1, 2]	V_O	–0.5 to V_{CC} + 0.5	V	Output: H or L
		–0.5 to 7.0		V_{CC}: OFF
Input clamp current	I_{IK}	–20	mA	V_I < 0
Output clamp current	I_{OK}	±50	mA	V_O < 0 or V_O > V_{CC}
Continuous output current	I_O	±25	mA	V_O = 0 to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air)*[3]	P_T	785	mW	SOP
		500		TSSOP
Storage temperature	Tstg	–65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

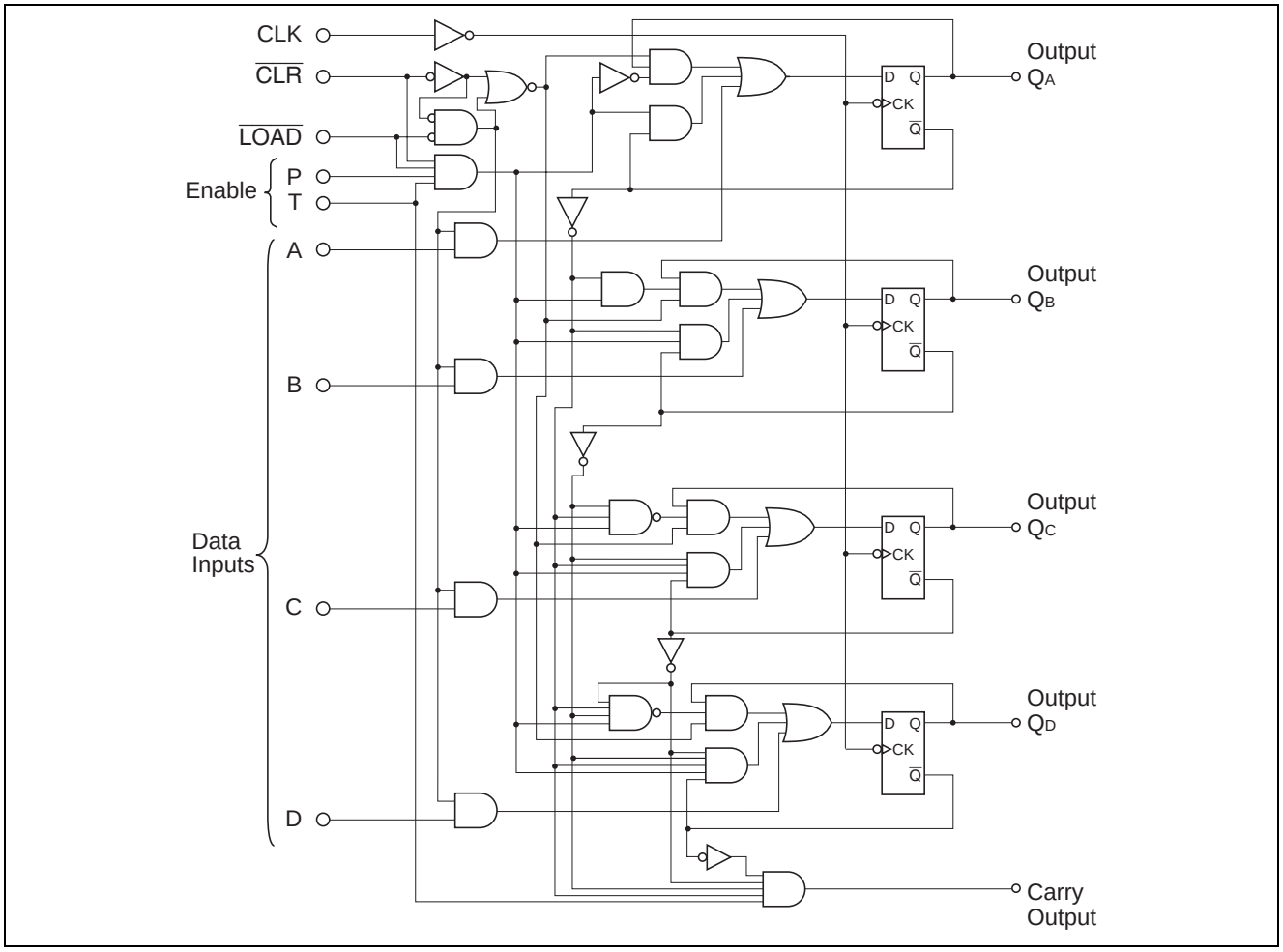
1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 5.5 V maximum.
3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

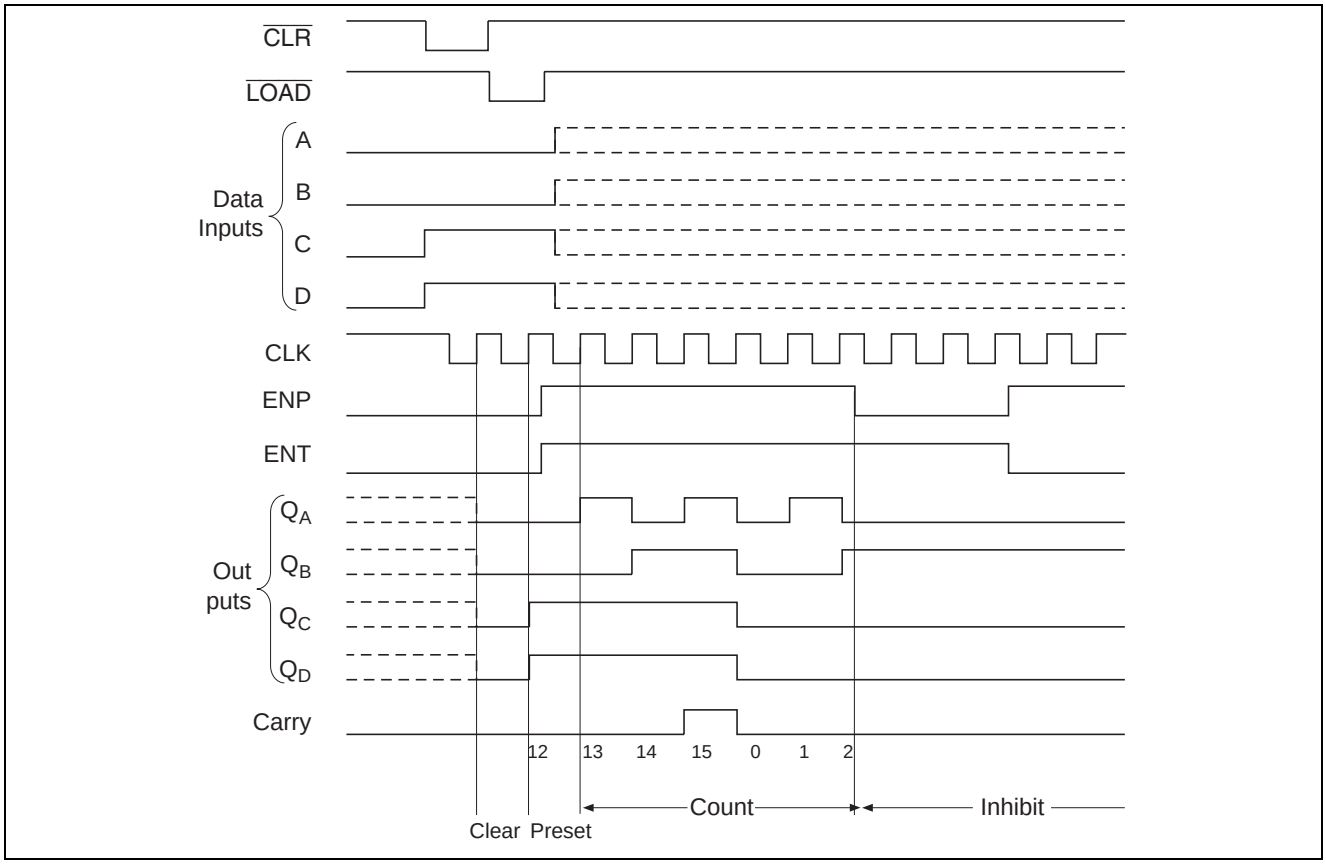
Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V_{CC}	2.0	5.5	V	
Input voltage range	V_I	0	5.5	V	
Output voltage range	V_O	0	V_{CC}	V	H or L
Output current	I_{OH}	—	–50	µA	V_{CC} = 2.0 V
		—	–2	mA	V_{CC} = 2.3 to 2.7 V
		—	–6		V_{CC} = 3.0 to 3.6 V
		—	–12		V_{CC} = 4.5 to 5.5 V
	I_{OL}	—	50	µA	V_{CC} = 2.0 V
		—	2	mA	V_{CC} = 2.3 to 2.7 V
		—	6		V_{CC} = 3.0 to 3.6 V
		—	12		V_{CC} = 4.5 to 5.5 V
Input transition rise or fall rate	Δt /Δv	0	200	ns/V	V_{CC} = 2.3 to 2.7 V
		0	100		V_{CC} = 3.0 to 3.6 V
		0	20		V_{CC} = 4.5 to 5.5 V
Operating free-air temperature	Ta	–40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



Timing Diagram



DC Electrical Characteristics

Ta = –40 to 85°C

Item	Symbol	V_{CC} (V)*	Min	Typ	Max	Unit	Test Conditions
Input voltage	V_{IH}	2.0	1.5	—	—	V	
		2.3 to 2.7	$V_{CC} \times 0.7$	—	—		
		3.0 to 3.6	$V_{CC} \times 0.7$	—	—		
		4.5 to 5.5	$V_{CC} \times 0.7$	—	—		
	V_{IL}	2.0	—	—	0.5		
		2.3 to 2.7	—	—	$V_{CC} \times 0.3$		
		3.0 to 3.6	—	—	$V_{CC} \times 0.3$		
		4.5 to 5.5	—	—	$V_{CC} \times 0.3$		
Output voltage	V_{OH}	Min to Max	V_{CC} – 0.1	—	—	V	I_{OL} = –50 µA
		2.3	2.0	—	—		I_{OL} = –2 mA
		3.0	2.48	—	—		I_{OL} = –6 mA
		4.5	3.8	—	—		I_{OL} = –12 mA
	V_{OL}	Min to Max	—	—	0.1		I_{OL} = 50 µA
		2.3	—	—	0.4		I_{OL} = 2 mA
		3.0	—	—	0.44		I_{OL} = 6 mA
		4.5	—	—	0.55		I_{OL} = 12 mA
Input current	I_{IN}	0 to 5.5	—	—	±1	µA	V_{IN} = 5.5 V or GND
Quiescent supply current	I_{CC}	5.5	—	—	20	µA	V_{IN} = V_{CC} or GND, I_O = 0
Output leakage current	I_{OFF}	0	—	—	5	µA	V_I or V_O = 0 V to 5.5 V
Input capacitance	C_{IN}	3.3	—	1.7	—	pF	V_I = V_{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

V_{CC} = 2.5 ± 0.2 V

Item	Symbol	Ta = 25°C			Ta = –40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	fmax	50	90	—	40	—	MHz	C_L = 15 pF		
		30	60	—	25	—		C_L = 50 pF		
Propagation delay time	t_{PLH}/t_{PHL}	—	11.1	16.2	1.0	19.5	ns	C_L = 15 pF	CLK	Q
		—	14.3	19.2	1.0	22.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	11.5	17.0	1.0	20.5		C_L = 15 pF	CLK	Carry
	Count mode	—	14.7	20.0	1.0	23.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	13.8	20.6	1.0	24.5		C_L = 15 pF	CLK	Carry
	Load mode	—	17.0	23.6	1.0	27.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	10.3	15.7	1.0	19.0		C_L = 15 pF	ENT	Carry
		—	14.0	18.7	1.0	22.0		C_L = 50 pF		
Setup time	t_{su}	7.5	—	—	8.5	—	ns		Data before CLK ↑	
		10.0	—	—	11.5	—			$\overline{\text{LOAD}}$ before CLK ↑	
		9.5	—	—	11.0	—			ENT, ENP before CLK ↑	
		6.0	—	—	6.0	—			$\overline{\text{CLR}}$ before CLK ↑	
Hold time	t_h	1.5	—	—	1.5	—	ns			
		1.5	—	—	1.5	—			$\overline{\text{CLR}}$ after CLK ↑	
Pulse width	t_w	7.0	—	—	7.0	—	ns		CLK H or L	

Switching Characteristics (cont)

VCC = 3.3 ± 0.3 V

Item	Symbol	Ta = 25°C Min	Typ	Max	Ta = –40 to 85°C Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Maximum clock frequency	t_{max}	80	130	—	70	—	MHz	C_L = 15 pF		
		55	85	—	50	—		C_L = 50 pF		
Propagation delay time	t_{PLH}/t_{PHL}	—	8.3	12.8	1.0	15.0	ns	C_L = 15 pF	CLK	Q
		—	10.8	16.3	1.0	18.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	8.7	13.6	1.0	16.0		C_L = 15 pF	CLK	Carry
	Count mode	—	11.2	17.1	1.0	19.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	11.0	17.2	1.0	20.0		C_L = 15 pF	CLK	Carry
	Load mode	—	13.5	20.7	1.0	23.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	7.5	12.3	1.0	14.5		C_L = 15 pF	ENT	Carry
		—	10.5	15.8	1.0	18.0		C_L = 50 pF		
Setup time	t_{su}	5.5	—	—	6.5	—	ns		Data before CLK ↑	
		8.0	—	—	9.5	—			$\overline{LOAD}$ before CLK ↑	
		7.5	—	—	9.0	—			ENT, ENP before CLK ↑	
		4.0	—	—	4.0	—			$\overline{CLR}$ before CLK ↑	
Hold time	t_h	1.0	—	—	1.0	—	ns			
		1.0	—	—	1.0	—			$\overline{CLR}$ after CLK ↑	
Pulse width	t_w	5.0	—	—	5.0	—	ns		CLK H or L	

V_{CC} = 5.0 ± 0.5 V

Item	Symbol	Ta = 25°C Min	Typ	Max	Ta = –40 to 85°C Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Maximum clock frequency	t_{max}	135	185	—	115	—	MHz	C_L = 15 pF		
		95	125	—	85	—		C_L = 50 pF		
Propagation delay time	t_{PLH}/t_{PHL}	—	4.9	8.1	1.0	9.5	ns	C_L = 15 pF	CLK	Q
		—	8.7	10.1	1.0	11.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	4.9	8.1	1.0	9.5		C_L = 15 pF	CLK	Carry
	Count mode	—	6.4	10.1	1.0	11.5		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	6.2	10.3	1.0	12.0		C_L = 15 pF	CLK	Carry
	Load mode	—	7.7	12.3	1.0	14.0		C_L = 50 pF		
	t_{PLH}/t_{PHL}	—	4.9	8.1	1.0	9.5		C_L = 15 pF	ENT	Carry
		—	6.4	10.1	1.0	11.5		C_L = 50 pF		
Setup time	t_{su}	4.5	—	—	4.5	—	ns		Data before CLK ↑	
		5.0	—	—	6.0	—			$\overline{LOAD}$ before CLK ↑	
		5.0	—	—	6.0	—			ENT, ENP before CLK ↑	
		3.5	—	—	3.5	—			$\overline{CLR}$ before CLK ↑	
Hold time	t_h	1.0	—	—	1.0	—	ns			
		1.5	—	—	1.5	—			$\overline{CLR}$ after CLK ↑	
Pulse width	t_w	5.0	—	—	5.0	—	ns		CLK H or L	

Operating Characteristics

C_L = 50 pF

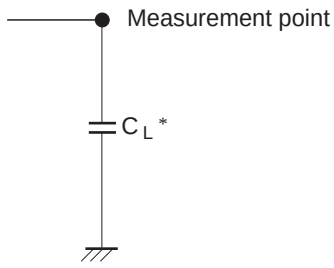
Item	Symbol	V_{CC} (V)	Ta = 25°C Min	Typ	Max	Unit	Test Conditions
Power dissipation capacitance	C_{PD}	3.3	—	17.3	—	pF	f = 10 MHz
		5.0	—	20.6	—		

Noise Characteristics

C_L = 50 pF

Item	Symbol	V_{CC} (V)	Ta = 25°C Min	Typ	Max	Unit	Test Conditions
Quiet output, maximum dynamic V_{OL}	$V_{OL (P)}$	3.3	—	0.3	0.8	V	
Quiet output, minimum dynamic V_{OL}	$V_{OL (V)}$	3.3	—	–0.3	–0.8	V	
Quiet output, minimum dynamic V_{OH}	$V_{OH (V)}$	3.3	—	3.0	—	V	
High-level dynamic input voltage	$V_{IH (D)}$	3.3	2.31	—	—	V	
Low-level dynamic input voltage	$V_{IL (D)}$	3.3	—	—	0.99	V	

Test Circuit

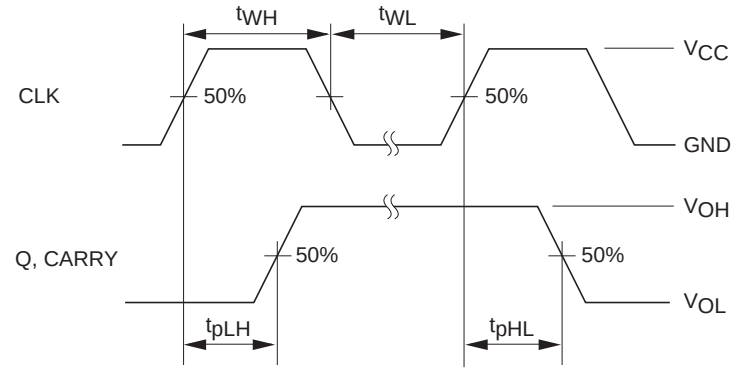


Note: 1. C_L includes the probe and jig capacitance.

Waveforms

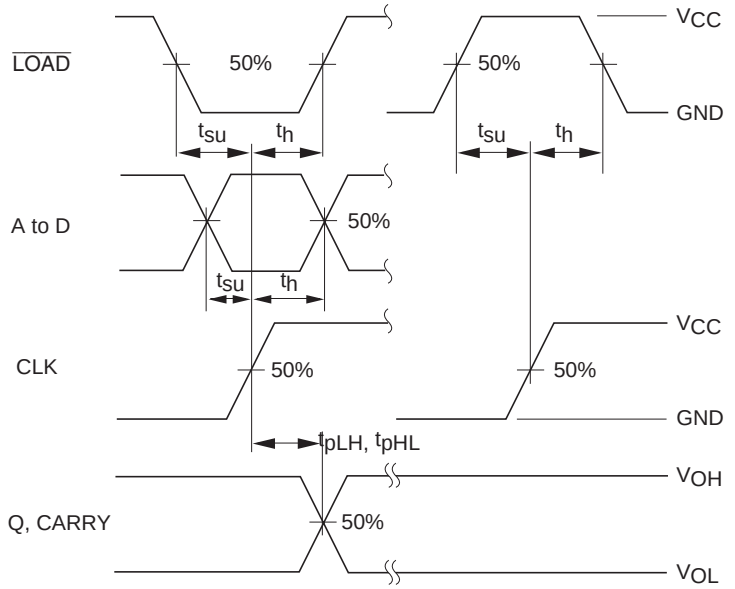
Waveform – 1

Count mode



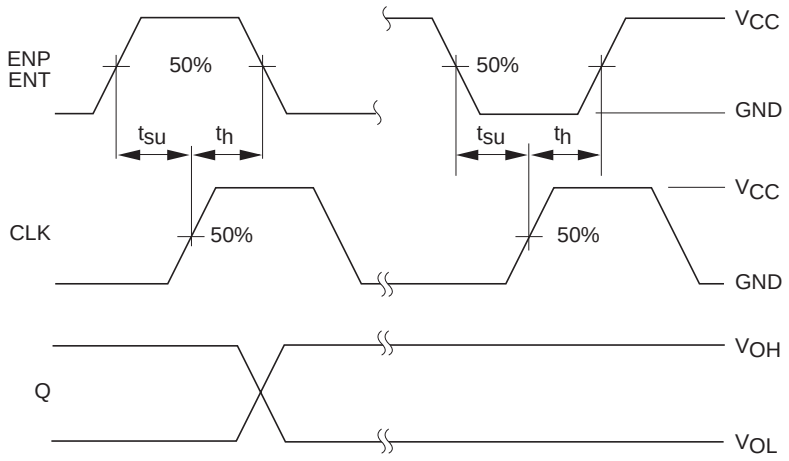
Waveform – 2

Preset mode



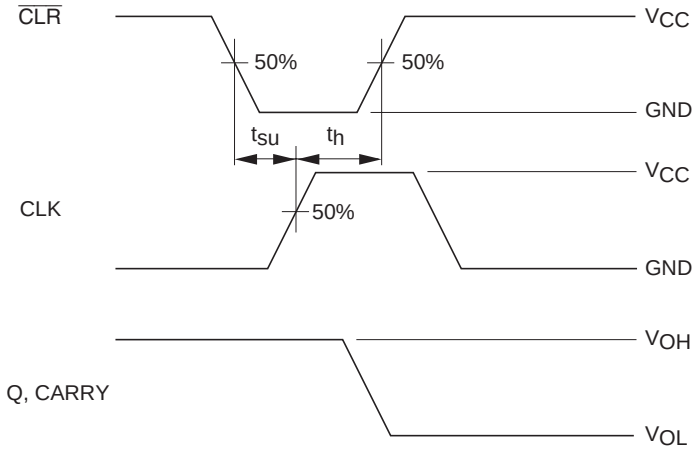
Waveform – 3

Count enable mode



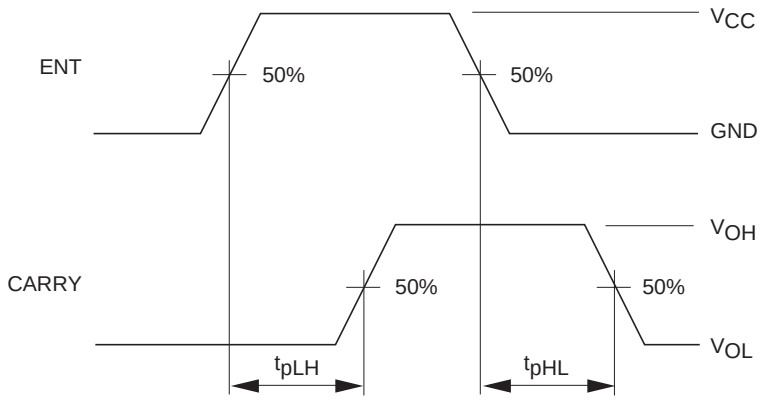
Waveform – 4

Clear mode



Waveform – 5

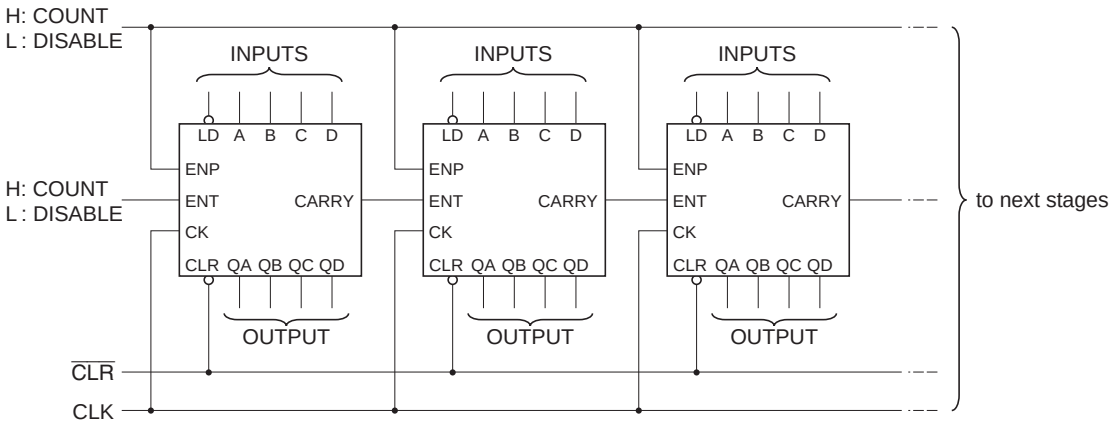
Cascade mode
(set to maximum count number)



Note: 1. Input waveform: PRR≤1 MHz, duty cycle 50%, t_r ≤3 ns, t_f ≤3 ns

Application

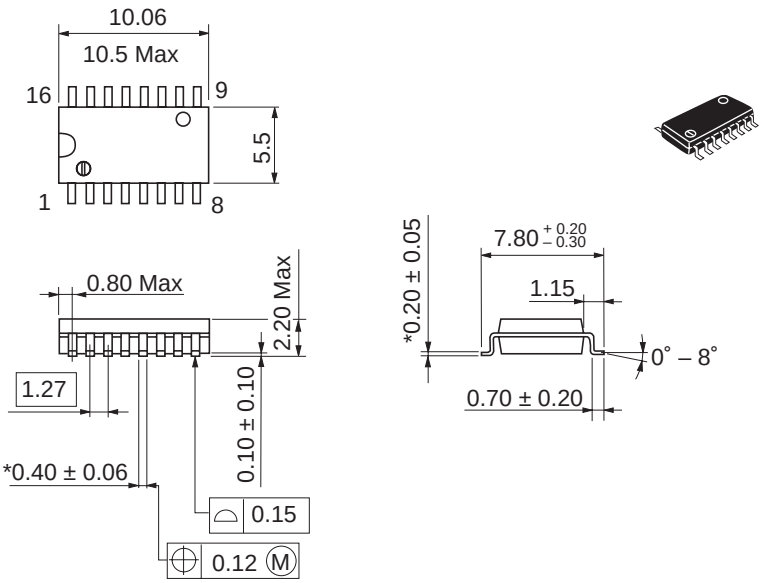
Cascade circuitry



Package Dimensions

As of January, 2003

Unit: mm

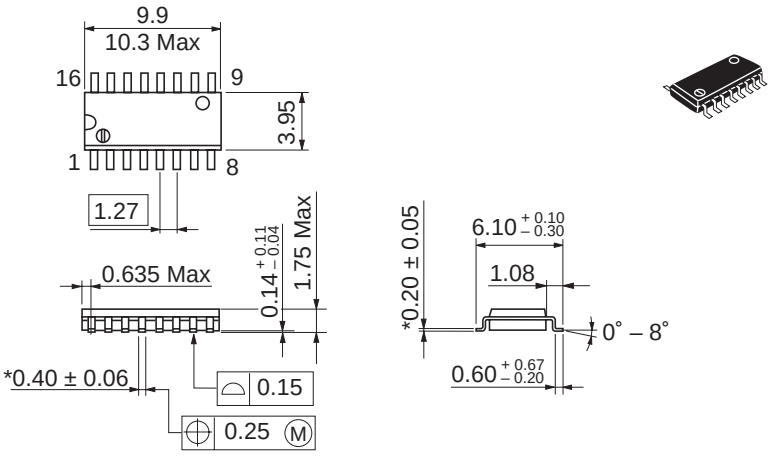


*Ni/Pd/Au plating

Package Code	FP-16DAV
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.24 g

As of January, 2003

Unit: mm

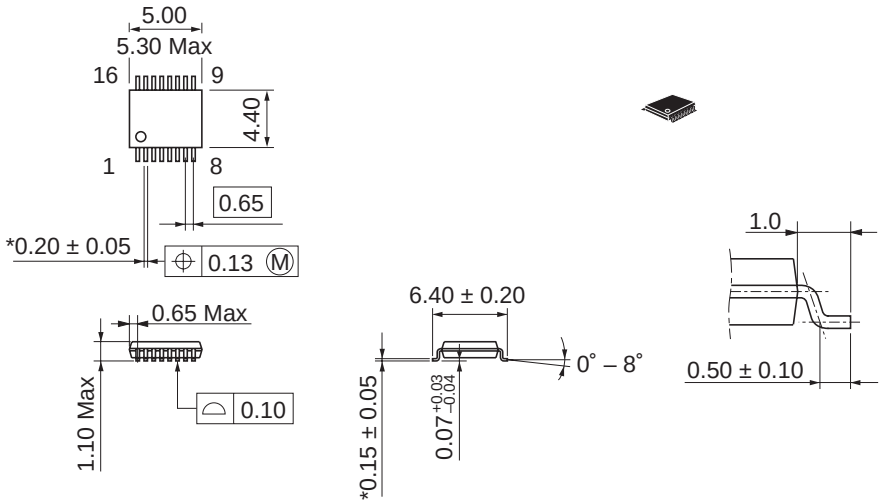


*Ni/Pd/Au plating

Package Code	FP-16DNV
JEDEC	Conforms
JEITA	Conforms
Mass (reference value)	0.15 g

As of January, 2003

Unit: mm



*Ni/Pd/Au plating

Package Code	TTP-16DAV
JEDEC	—
JEITA	—
Mass (reference value)	0.05 g

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